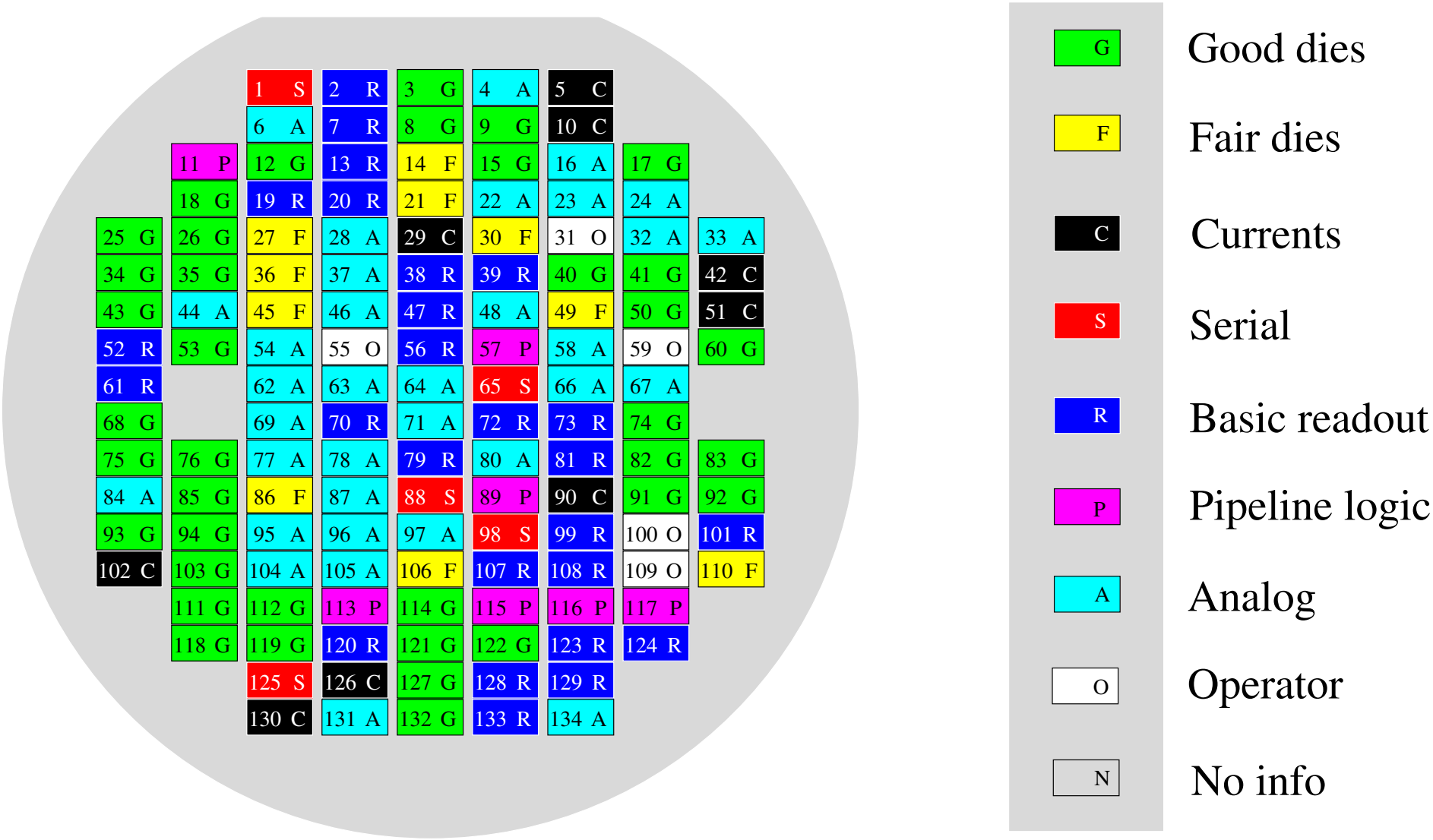
Types of die failures for wafer 170 s/n: Y21316-12-18

Date: 07/06/99